IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): TAKEUCHI, et al.

Application No.: 10/591,696

Filed: September 5, 2006

For: Prepreg, Metal-Clad Laminate and Printed Circuit Board

USING SAME

RESPONSE TO NOTICE TO FILE MISSING PARTS

Mail Stop Missing Parts Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

July 16, 2007

Sir:

In response to the Notice to File Missing Parts dated May 14, 2007, in connection with the above-identified application, attached hereto is an executed Declaration for the above-identified patent application, in compliance with 37 CFR 1.63.

The fee of \$130.00 required to satisfy the requirements set forth in 37 CFR 1.16(f) is being submitted electronically at the time of filing this response.

Please charge any shortages in the fees due in connection with the filing of this paper, including extension of time fees, to Deposit Account No. 01-2135 (Docket No. 1303.46565X00) and please credit any excess fees to such deposit account.

Respectfully submitted,

/William I. Solomon/ William I. Solomon Registration No. 28,565

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